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Details

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	40MHz
Connectivity	I ² C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, HLVD, POR, PWM, WDT
Number of I/O	36
Program Memory Size	32KB (16K x 16)
Program Memory Type	FLASH
EEPROM Size	256 x 8
RAM Size	1.5K x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 5.5V
Data Converters	A/D 13x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	44-TQFP
Supplier Device Package	44-TQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic18lf4523-i-pt

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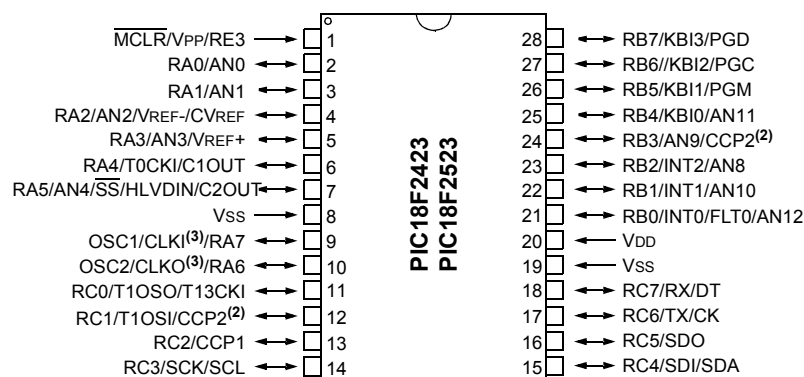
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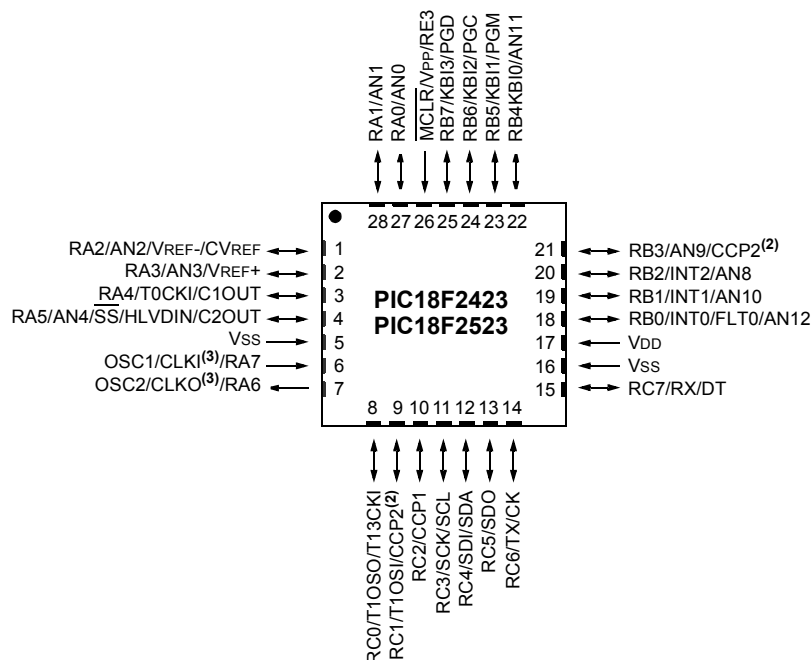
PIC18F2423/2523/4423/4523

Pin Diagrams

28-Pin PDIP, SOIC



28-Pin QFN⁽¹⁾

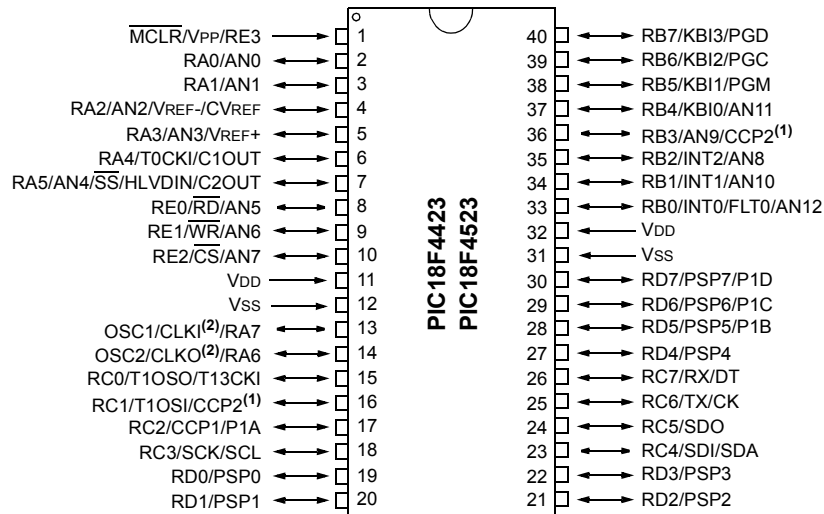


- Note**
- 1: It is recommended to connect the bottom pad of QFN package parts to Vss.
 - 2: RB3 is the alternate pin for CCP2 multiplexing.
 - 3: OSC1/CLKI and OSC2/CLKO are only available in select oscillator modes and when these pins are not being used as digital I/O. For additional information, see **Section 2.0 "Oscillator Configurations"** of the "PIC18F2420/2520/4420/4520 Data Sheet" (DS39631).

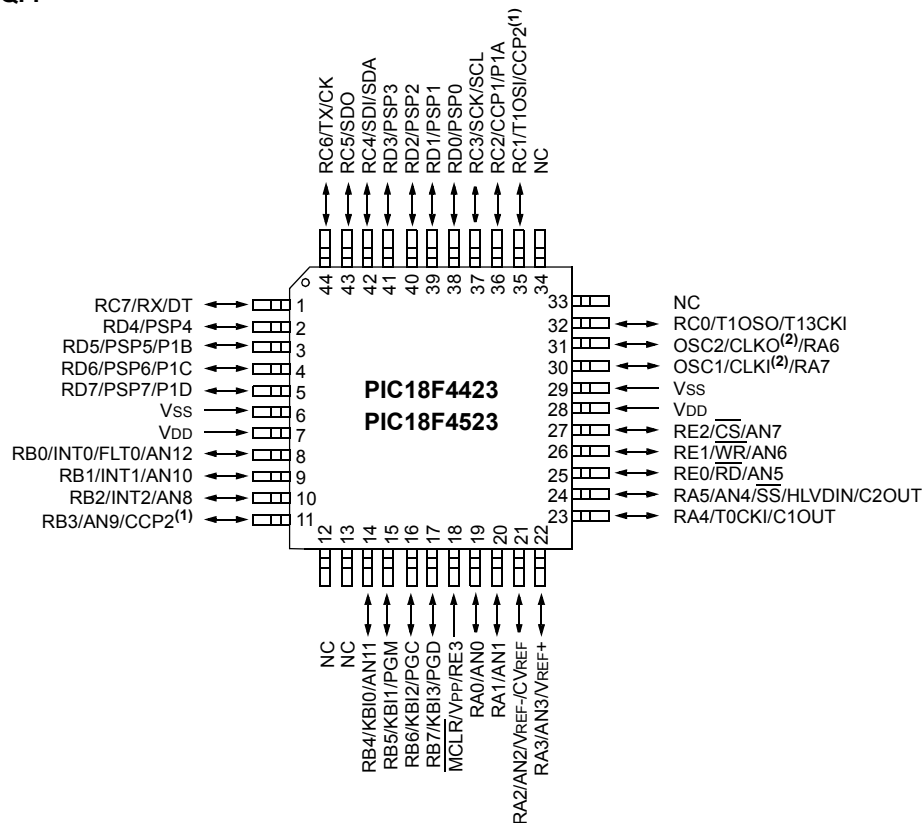
PIC18F2423/2523/4423/4523

Pin Diagrams (Continued)

40-Pin PDIP



44-Pin TQFP

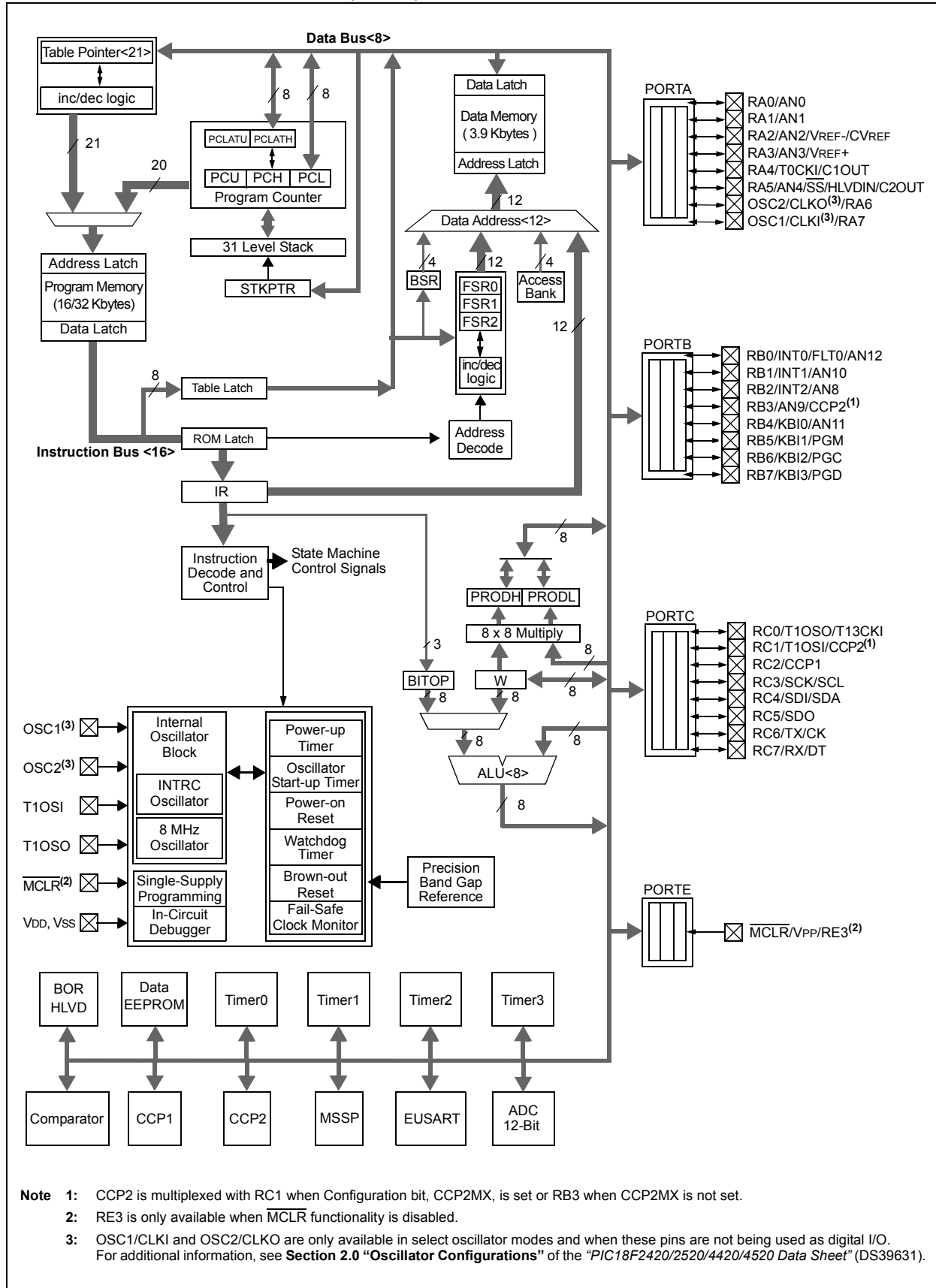


Note 1: RB3 is the alternate pin for CCP2 multiplexing.

Note 2: OSC1/CLKI and OSC2/CLKO are only available in select oscillator modes and when these pins are not being used as digital I/O. For additional information, see **Section 2.0 "Oscillator Configurations"** of the "PIC18F2420/2520/4420/4520 Data Sheet" (DS39631).

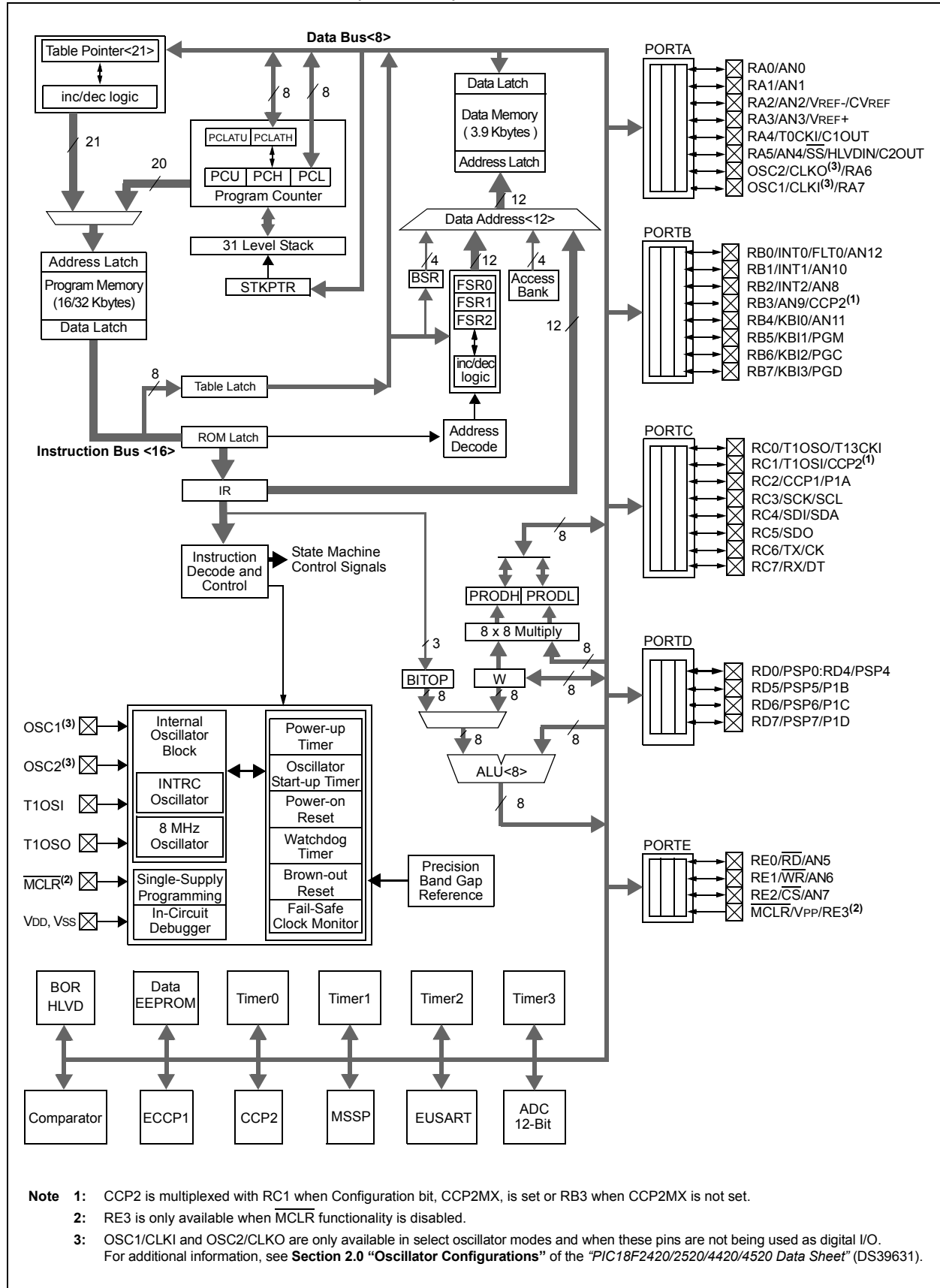
PIC18F2423/2523/4423/4523

FIGURE 1-1: PIC18F2423/2523 (28-PIN) BLOCK DIAGRAM



PIC18F2423/2523/4423/4523

FIGURE 1-2: PIC18F4423/4523 (40/44-PIN) BLOCK DIAGRAM



PIC18F2423/2523/4423/4523

TABLE 1-2: PIC18F2423/2523 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number		Pin Type	Buffer Type	Description
	PDIP, SOIC	QFN			
RA0/AN0	2	27	I/O	TTL	PORTA is a bidirectional I/O port.
RA0			I	Analog	Digital I/O.
AN0					Analog Input 0.
RA1/AN1	3	28	I/O	TTL	Digital I/O.
RA1			I	Analog	Analog Input 1.
AN1					
RA2/AN2/VREF-/CVREF	4	1	I/O	TTL	Digital I/O.
RA2			I	Analog	Analog Input 2.
AN2			I	Analog	A/D reference voltage (low) input.
VREF-					
CVREF			O	Analog	Comparator reference voltage output.
RA3/AN3/VREF+	5	2	I/O	TTL	Digital I/O.
RA3			I	Analog	Analog Input 3.
AN3			I	Analog	A/D reference voltage (high) input.
VREF+					
RA4/T0CKI/C1OUT	6	3	I/O	ST	Digital I/O.
RA4			I	ST	Timer0 external clock input.
T0CKI					
C1OUT			O	—	Comparator 1 output.
RA5/AN4/ \overline{SS} /HLVDIN/C2OUT	7	4	I/O	TTL	Digital I/O.
RA5			I	Analog	Analog Input 4.
AN4			I	TTL	SPI slave select input.
\overline{SS}			I	Analog	High/Low-Voltage Detect input.
HLVDIN					
C2OUT			O	—	Comparator 2 output.
RA6					See the OSC2/CLKO/RA6 pin.
RA7					See the OSC1/CLKI/RA7 pin.

Legend: TTL = TTL compatible input CMOS = CMOS compatible input or output
ST = Schmitt Trigger input with CMOS levels I = Input
O = Output P = Power
I²C = I²C™/SMBus

Note 1: Default assignment for CCP2 when Configuration bit, CCP2MX, is set.

2: Alternate assignment for CCP2 when Configuration bit, CCP2MX, is cleared.

PIC18F2423/2523/4423/4523

TABLE 1-2: PIC18F2423/2523 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number		Pin Type	Buffer Type	Description
	PDIP, SOIC	QFN			
RB0/INT0/FLT0/AN12	21	18	I/O	TTL	PORTB is a bidirectional I/O port. PORTB can be software programmed for internal weak pull-ups on all inputs.
RB0			I	ST	Digital I/O.
INT0			I	ST	External Interrupt 0.
FLT0			I	ST	PWM Fault input for CCP1.
AN12			I	Analog	Analog Input 12.
RB1/INT1/AN10	22	19	I/O	TTL	Digital I/O.
RB1			I	ST	External Interrupt 1.
INT1			I	ST	External Interrupt 1.
AN10			I	Analog	Analog Input 10.
RB2/INT2/AN8	23	20	I/O	TTL	Digital I/O.
RB2			I	ST	External Interrupt 2.
INT2			I	ST	External Interrupt 2.
AN8			I	Analog	Analog Input 8.
RB3/AN9/CCP2	24	21	I/O	TTL	Digital I/O.
RB3			I	Analog	Analog Input 9.
AN9			I	Analog	Analog Input 9.
CCP2 ⁽¹⁾			I/O	ST	Capture 2 input/Compare 2 output/PWM2 output.
RB4/KBI0/AN11	25	22	I/O	TTL	Digital I/O.
RB4			I	TTL	Interrupt-on-change pin.
KBI0			I	TTL	Interrupt-on-change pin.
AN11			I	Analog	Analog Input 11.
RB5/KBI1/PGM	26	23	I/O	TTL	Digital I/O.
RB5			I	TTL	Interrupt-on-change pin.
KBI1			I	TTL	Interrupt-on-change pin.
PGM			I/O	ST	Low-Voltage ICSP™ Programming enable pin.
RB6/KBI2/PGC	27	24	I/O	TTL	Digital I/O.
RB6			I	TTL	Interrupt-on-change pin.
KBI2			I	TTL	Interrupt-on-change pin.
PGC			I/O	ST	In-Circuit Debugger and ICSP programming clock pin.
RB7/KBI3/PGD	28	25	I/O	TTL	Digital I/O.
RB7			I	TTL	Interrupt-on-change pin.
KBI3			I	TTL	Interrupt-on-change pin.
PGD			I/O	ST	In-Circuit Debugger and ICSP programming data pin.

Legend: TTL = TTL compatible input CMOS = CMOS compatible input or output
ST = Schmitt Trigger input with CMOS levels I = Input
O = Output P = Power
I²C = I²C™/SMBus

Note 1: Default assignment for CCP2 when Configuration bit, CCP2MX, is set.
Note 2: Alternate assignment for CCP2 when Configuration bit, CCP2MX, is cleared.

PIC18F2423/2523/4423/4523

TABLE 1-2: PIC18F2423/2523 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number		Pin Type	Buffer Type	Description
	PDIP, SOIC	QFN			
RC0/T1OSO/T13CKI RC0 T1OSO T13CKI	11	8	I/O O I	ST — ST	PORTC is a bidirectional I/O port. Digital I/O. Timer1 oscillator output. Timer1/Timer3 external clock input.
RC1/T1OSI/CCP2 RC1 T1OSI CCP2 ⁽²⁾	12	9	I/O I I/O	ST Analog ST	Digital I/O. Timer1 oscillator input. Capture 2 input/Compare 2 output/PWM2 output.
RC2/CCP1 RC2 CCP1	13	10	I/O I/O	ST ST	Digital I/O. Capture 1 input/Compare 1 output/PWM1 output.
RC3/SCK/SCL RC3 SCK SCL	14	11	I/O I/O I/O	ST ST I ² C	Digital I/O. Synchronous serial clock input/output for SPI mode. Synchronous serial clock input/output for I ² C™ mode.
RC4/SDI/SDA RC4 SDI SDA	15	12	I/O I I/O	ST ST I ² C	Digital I/O. SPI data in. I ² C data I/O.
RC5/SDO RC5 SDO	16	13	I/O O	ST —	Digital I/O. SPI data out.
RC6/TX/CK RC6 TX CK	17	14	I/O O I/O	ST — ST	Digital I/O. EUSART asynchronous transmit. EUSART synchronous clock (see related RX/DT).
RC7/RX/DT RC7 RX DT	18	15	I/O I I/O	ST ST ST	Digital I/O. EUSART asynchronous receive. EUSART synchronous data (see related TX/CK).
RE3	—	—	—	—	See MCLR/VPP/RE3 pin.
Vss	8, 19	5, 16	P	—	Ground reference for logic and I/O pins.
VDD	20	17	P	—	Positive supply for logic and I/O pins.

Legend: TTL = TTL compatible input CMOS = CMOS compatible input or output
ST = Schmitt Trigger input with CMOS levels I = Input
O = Output P = Power
I²C = I²C™/SMBus

Note 1: Default assignment for CCP2 when Configuration bit, CCP2MX, is set.

2: Alternate assignment for CCP2 when Configuration bit, CCP2MX, is cleared.

PIC18F2423/2523/4423/4523

TABLE 1-3: PIC18F4423/4523 PINOUT I/O DESCRIPTIONS

Pin Name	Pin Number			Pin Type	Buffer Type	Description
	PDIP	QFN	TQFP			
MCLR/VPP/RE3 MCLR VPP RE3	1	18	18	I P I	ST ST	Master Clear (input) or programming voltage (input). Master Clear (Reset) input. This pin is an active-low Reset to the device. Programming voltage input. Digital input.
OSC1/CLKI/RA7 OSC1 CLKI RA7	13	32	30	I I I/O	ST CMOS TTL	Oscillator crystal or external clock input. Oscillator crystal input or external clock source input. ST buffer when configured in RC mode; analog otherwise. External clock source input. Always associated with pin function, OSC1. (See related OSC1/CLKI, OSC2/CLKO pins.) General purpose I/O pin.
OSC2/CLKO/RA6 OSC2 CLKO RA6	14	33	31	O O I/O	— — TTL	Oscillator crystal or clock output. Oscillator crystal output. Connects to crystal or resonator in Crystal Oscillator mode. In RC mode, OSC2 pin outputs CLKO, which has 1/4 the frequency of OSC1 and denotes the instruction cycle rate. General purpose I/O pin.

Legend: TTL = TTL compatible input CMOS = CMOS compatible input or output
ST = Schmitt Trigger input with CMOS levels I = Input
O = Output P = Power
I²C = I²C™/SMBus

- Note 1:** Default assignment for CCP2 when Configuration bit, CCP2MX, is set.
2: Alternate assignment for CCP2 when Configuration bit, CCP2MX, is cleared.

PIC18F2423/2523/4423/4523

TABLE 1-3: PIC18F4423/4523 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number			Pin Type	Buffer Type	Description
	PDIP	QFN	TQFP			
RC0/T1OSO/T13CKI	15	34	32	I/O	ST	PORTC is a bidirectional I/O port. Digital I/O. Timer1 oscillator output. Timer1/Timer3 external clock input.
RC0				O	—	
T1OSO				I	ST	
T13CKI						
RC1/T1OSI/CCP2	16	35	35	I/O	ST	Digital I/O. Timer1 oscillator input. Capture 2 input/Compare 2 output/PWM2 output.
RC1				I	CMOS	
T1OSI				I/O	ST	
CCP2 ⁽²⁾						
RC2/CCP1/P1A	17	36	36	I/O	ST	Digital I/O. Capture 1 input/Compare 1 output/PWM1 output. Enhanced CCP1 output.
RC2				I/O	ST	
CCP1				O	—	
P1A						
RC3/SCK/SCL	18	37	37	I/O	ST	Digital I/O. Synchronous serial clock input/output for SPI mode. Synchronous serial clock input/output for I ² C™ mode.
RC3				I/O	ST	
SCK				I/O	I ² C	
SCL						
RC4/SDI/SDA	23	42	42	I/O	ST	Digital I/O. SPI data in. I ² C data I/O.
RC4				I	ST	
SDI				I/O	I ² C	
SDA						
RC5/SDO	24	43	43	I/O	ST	Digital I/O. SPI data out.
RC5				O	—	
SDO						
RC6/TX/CK	25	44	44	I/O	ST	Digital I/O. EUSART asynchronous transmit. EUSART synchronous clock (see related RX/DT).
RC6				O	—	
TX				I/O	ST	
CK						
RC7/RX/DT	26	1	1	I/O	ST	Digital I/O. EUSART asynchronous receive. EUSART synchronous data (see related TX/CK).
RC7				I	ST	
RX				I/O	ST	
DT						

Legend: TTL = TTL compatible input
ST = Schmitt Trigger input with CMOS levels
O = Output
I²C = I²C™/SMBus
CMOS = CMOS compatible input or output
I = Input
P = Power

Note 1: Default assignment for CCP2 when Configuration bit, CCP2MX, is set.

2: Alternate assignment for CCP2 when Configuration bit, CCP2MX, is cleared.

PIC18F2423/2523/4423/4523

TABLE 1-3: PIC18F4423/4523 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number			Pin Type	Buffer Type	Description
	PDIP	QFN	TQFP			
RE0/ $\overline{\text{RD}}$ /AN5 RE0 $\overline{\text{RD}}$ AN5	8	25	25	I/O I I	ST TTL Analog	<p>PORTE is a bidirectional I/O port.</p> <p>Digital I/O. Read control for Parallel Slave Port (see also $\overline{\text{WR}}$ and $\overline{\text{CS}}$ pins). Analog Input 5.</p>
RE1/ $\overline{\text{WR}}$ /AN6 RE1 $\overline{\text{WR}}$ AN6	9	26	26	I/O I I	ST TTL Analog	<p>Digital I/O. Write control for Parallel Slave Port (see $\overline{\text{CS}}$ and $\overline{\text{RD}}$ pins). Analog Input 6.</p>
RE2/ $\overline{\text{CS}}$ /AN7 RE2 $\overline{\text{CS}}$ AN7	10	27	27	I/O I I	ST TTL Analog	<p>Digital I/O. Chip select control for Parallel Slave Port (see related $\overline{\text{RD}}$ and $\overline{\text{WR}}$). Analog Input 7.</p>
RE3	—	—	—	—	—	See $\overline{\text{MCLR}}/\text{VPP}/\text{RE3}$ pin.
Vss	12, 31	6, 30, 31	6, 29	P	—	Ground reference for logic and I/O pins.
VDD	11, 32	7, 8, 28, 29	7, 28	P	—	Positive supply for logic and I/O pins.
NC	—	13	12, 13, 33, 34	—	—	No connect.

Legend: TTL = TTL compatible input CMOS = CMOS compatible input or output
ST = Schmitt Trigger input with CMOS levels I = Input
O = Output P = Power
I²C = I²C™/SMBus

Note 1: Default assignment for CCP2 when Configuration bit, CCP2MX, is set.

2: Alternate assignment for CCP2 when Configuration bit, CCP2MX, is cleared.

PIC18F2423/2523/4423/4523

NOTES:

2.6 A/D Conversions

Figure 2-4 shows the operation of the A/D Converter after the $\overline{\text{GO/DONE}}$ bit has been set and the $\text{ACQT}<2:0>$ bits are cleared. A conversion is started after the following instruction to allow entry into Sleep mode before the conversion begins.

Figure 2-5 shows the operation of the A/D Converter after the $\overline{\text{GO/DONE}}$ bit has been set, the $\text{ACQT}<2:0>$ bits have been set to '010' and a 4 TAD acquisition time has been selected before the conversion starts.

Clearing the $\overline{\text{GO/DONE}}$ bit during a conversion will abort the current conversion. The A/D Result register pair will NOT be updated with the partially completed A/D conversion sample. This means, the ADRESH:ADRESL registers will continue to contain the value of the last completed conversion (or the last value written to the ADRESH:ADRESL registers).

After the A/D conversion is completed or aborted, a 2 Tcy wait is required before the next acquisition can be started. After this wait, acquisition on the selected channel is automatically started.

Note: The $\overline{\text{GO/DONE}}$ bit should **NOT** be set in the same instruction that turns on the A/D. Code should wait at least 3 TAD after enabling the A/D before beginning an acquisition and conversion cycle.

2.7 Discharge

The discharge phase is used to initialize the value of the holding capacitor. The array is discharged before every sample. This feature helps to optimize the unity-gain amplifier, as the circuit always needs to charge the capacitor array, rather than charge/discharge based on previous measure values.

FIGURE 2-4: A/D CONVERSION TAD CYCLES ($\text{ACQT}<2:0> = 000$, $\text{Tacq} = 0$)

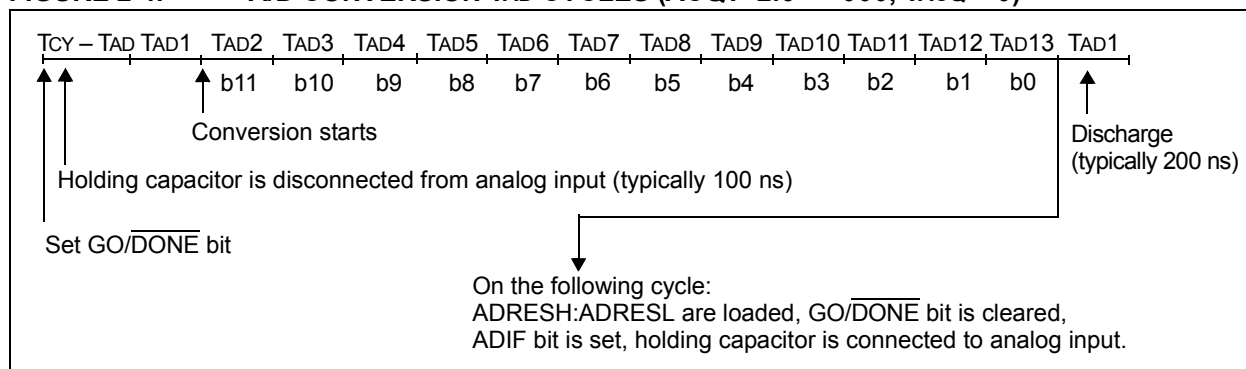
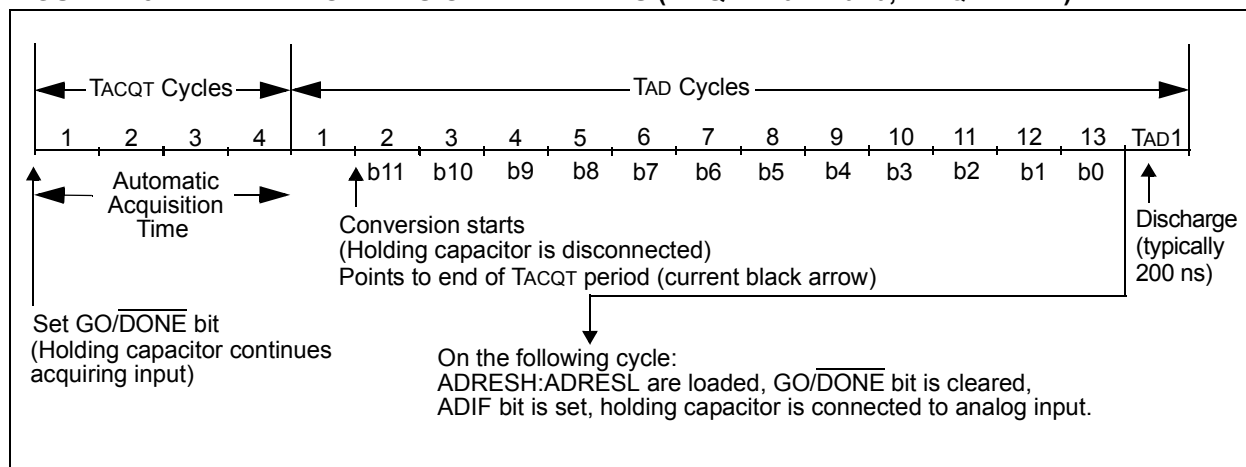


FIGURE 2-5: A/D CONVERSION TAD CYCLES ($\text{ACQT}<2:0> = 010$, $\text{Tacq} = 4 \text{ TAD}$)



PIC18F2423/2523/4423/4523

REGISTER 3-2: DEVID2: DEVICE ID REGISTER 2 FOR PIC18F2423/2523/4423/4523

R	R	R	R	R	R	R	R
DEV11 ⁽¹⁾	DEV10 ⁽¹⁾	DEV9 ⁽¹⁾	DEV8 ⁽¹⁾	DEV7 ⁽¹⁾	DEV6 ⁽¹⁾	DEV5 ⁽¹⁾	DEV4 ⁽¹⁾
bit 7							bit 0

Legend:

R = Read-only bit

P = Programmable bit

U = Unimplemented bit, read as '0'

-n = Value when device is unprogrammed

u = Unchanged from programmed state

bit 7-0 **DEV<11:4>**: Device ID bits⁽¹⁾

These bits are used with the DEV<3:0> bits in Device ID Register 1 to identify the part number.

0001 0001 = PIC18F2423/2523 devices

0001 0000 = PIC18F4423/4523 devices

Note 1: These values for DEV<11:4> may be shared with other devices. The specific device is always identified by using the entire DEV<11:0> bit sequence.

PIC18F2423/2523/4423/4523

FIGURE 4-1: PIC18F2423/2523/4423/4523 VOLTAGE-FREQUENCY GRAPH (INDUSTRIAL)

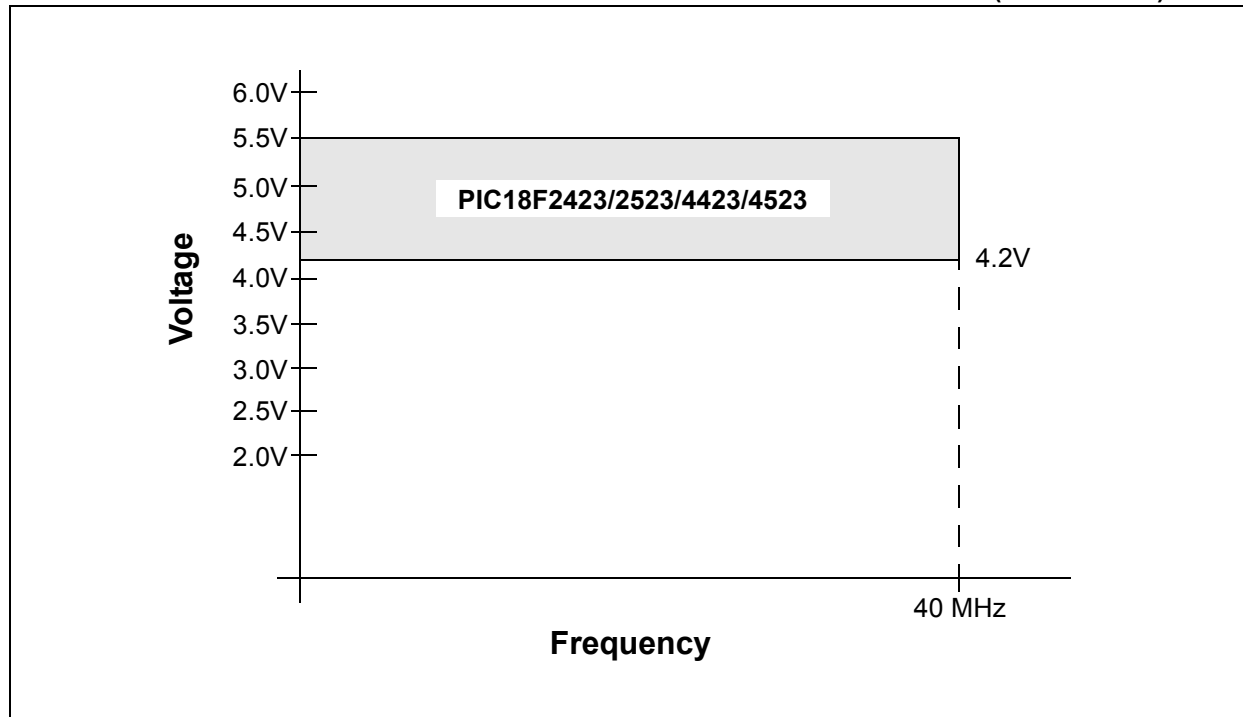
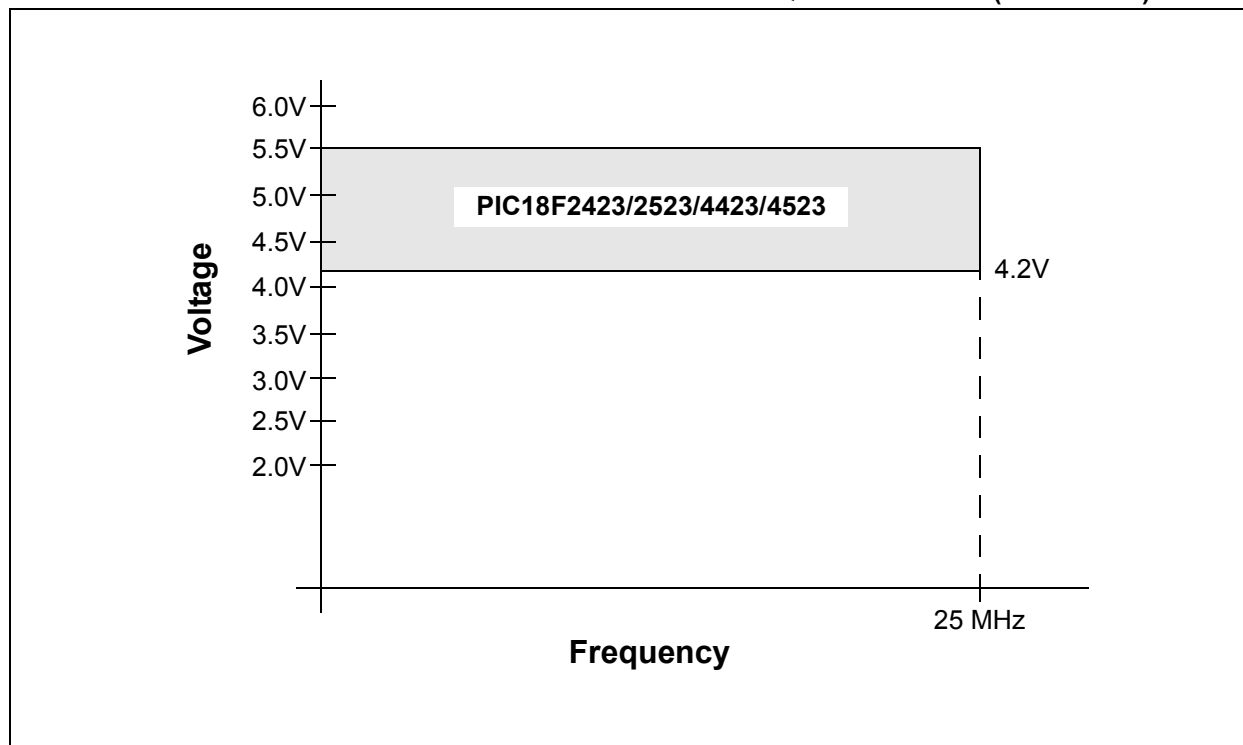
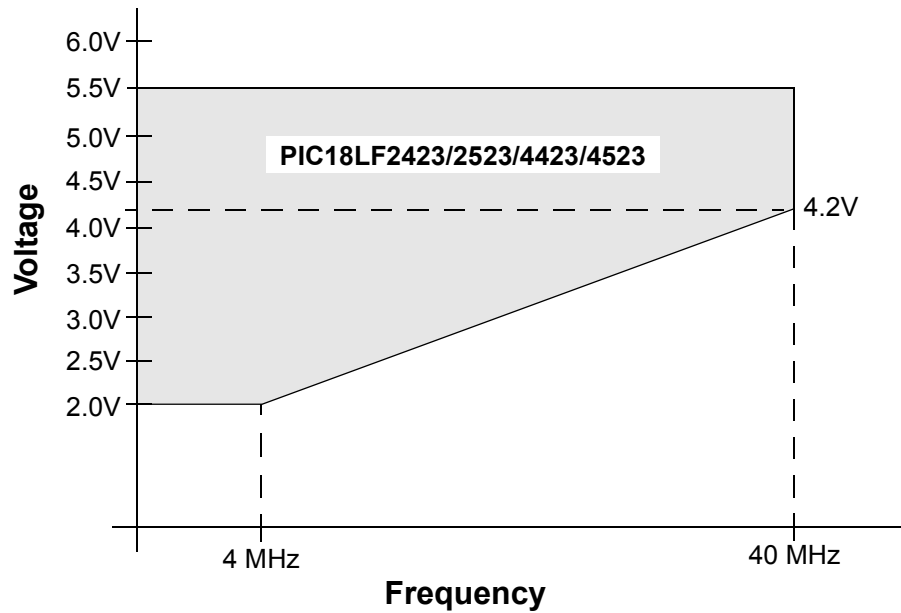


FIGURE 4-2: PIC18F2423/2523/4423/4523 VOLTAGE-FREQUENCY GRAPH (EXTENDED)



PIC18F2423/2523/4423/4523

FIGURE 4-3: PIC18LF2423/2523/4423/4523 VOLTAGE-FREQUENCY GRAPH (INDUSTRIAL)



$$F_{MAX} = (16.36 \text{ MHz/V}) (V_{DDAPP\text{MIN}} - 2.0\text{V}) + 4 \text{ MHz}$$

Note: $V_{DDAPP\text{MIN}}$ is the minimum voltage of the PIC[®] device in the application.

PIC18F2423/2523/4423/4523

**TABLE 4-1: A/D CONVERTER CHARACTERISTICS: PIC18F2423/2523/4423/4523 (INDUSTRIAL)
PIC18LF2423/2523/4423/4523 (INDUSTRIAL)**

Param No.	Sym	Characteristic	Min	Typ	Max	Units	Conditions	
A01	NR	Resolution	—	—	12	bit		$\Delta V_{REF} \geq 3.0V$
A03	EIL	Integral Linearity Error	—	$<\pm 1$	± 2.0	LSB	$V_{DD} = 3.0V$	$\Delta V_{REF} \geq 3.0V$
			—	—	± 2.0	LSB	$V_{DD} = 5.0V$	
A04	EDL	Differential Linearity Error	—	$<\pm 1$	$+1.5/-1.0$	LSB	$V_{DD} = 3.0V$	$\Delta V_{REF} \geq 3.0V$
			—	—	$+1.5/-1.0$	LSB	$V_{DD} = 5.0V$	
A06	EOFF	Offset Error	—	$<\pm 1$	± 5	LSB	$V_{DD} = 3.0V$	$\Delta V_{REF} \geq 3.0V$
			—	—	± 3	LSB	$V_{DD} = 5.0V$	
A07	EGN	Gain Error	—	$<\pm 1$	± 1.25	LSB	$V_{DD} = 3.0V$	$\Delta V_{REF} \geq 3.0V$
			—	—	± 2.00	LSB	$V_{DD} = 5.0V$	
A10	—	Monotonicity	Guaranteed ⁽¹⁾			—		$V_{SS} \leq V_{AIN} \leq V_{REF}$
A20	ΔV_{REF}	Reference Voltage Range ($V_{REFH} - V_{REFL}$)	3	—	$V_{DD} - V_{SS}$	V		For 12-bit resolution.
A21	V_{REFH}	Reference Voltage High	$V_{SS} + 3.0V$	—	$V_{DD} + 0.3V$	V		For 12-bit resolution.
A22	V_{REFL}	Reference Voltage Low	$V_{SS} - 0.3V$	—	$V_{DD} - 3.0V$	V		For 12-bit resolution.
A25	V_{AIN}	Analog Input Voltage	V_{REFL}	—	V_{REFH}	V		
A30	Z_{AIN}	Recommended Impedance of Analog Voltage Source	—	—	2.5	k Ω		
A50	I _{REF}	V _{REF} Input Current ⁽²⁾	—	—	5	μA		During V _{AIN} acquisition. During A/D conversion cycle.
			—	—	150	μA		

- Note 1:** The A/D conversion result never decreases with an increase in the input voltage and has no missing codes.
- Note 2:** V_{REFH} current is from the RA3/AN3/V_{REF}+ pin or V_{DD}, whichever is selected as the V_{REFH} source. V_{REFL} current is from the RA2/AN2/V_{REF}-/CV_{REF} pin or V_{SS}, whichever is selected as the V_{REFL} source.

APPENDIX E: MIGRATION FROM MID-RANGE TO ENHANCED DEVICES

A detailed discussion of the differences between the mid-range MCU devices (i.e., PIC16CXXX) and the enhanced devices (i.e., PIC18FXXX) is provided in AN716, *"Migrating Designs from PIC16C74A/74B to PIC18C442"*. The changes discussed, while device specific, are generally applicable to all mid-range to enhanced device migrations.

This Application Note is available as Literature Number DS00716.

APPENDIX F: MIGRATION FROM HIGH-END TO ENHANCED DEVICES

A detailed discussion of the migration pathway and differences between the high-end MCU devices (i.e., PIC17CXXX) and the enhanced devices (i.e., PIC18FXXX) is provided in AN726, *"PIC17CXXX to PIC18CXXX Migration"*. This Application Note is available as Literature Number DS00726.

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